



566.43481CC4

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): N. Fukutomi, et al.

Appln. No. 10/042,408

Filed: January 8, 2002

For: FABRICATION PROCESS OF SEMICONDUCTOR PACKAGE AND
SEMICONDUCTOR PACKAGE

Group: 2813

Examiner: N. Berezny

AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

March 2, 2005

Sir:

In response to the Office Action mailed November 2, 2004, please amend the above-identified application as listed in the following, and as set forth on the following pages:

Amendments to the Claims; and

Remarks are included following the amendments.